

SURFACE MOUNT SWITCHING DIODES

Voltage

100~250 V

POWER

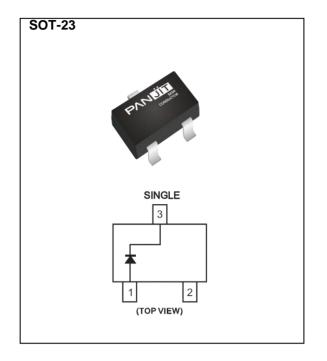
350 mW

Features

- Fast switching speed.
- Surface mount package Ideally Suited for Automatic insertion
- Electrically Identical to Standard JEDEC
- High Conductance
- Lead free in compliance with EU RoHS 2.0
- Green molding compound as per IEC 61249 standard
- AEC-Q101 qualified

Mechanical Data

- Case: SOT-23, Plastic
- Terminals: Solder plated, solderable per MIL-STD-750, Method 2026
- Approx. Weight: 0.0003 ounces, 0.0084 grams



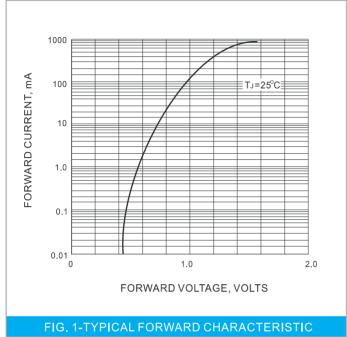
Maximum Ratings (T_A=25°C unless otherwise noted)

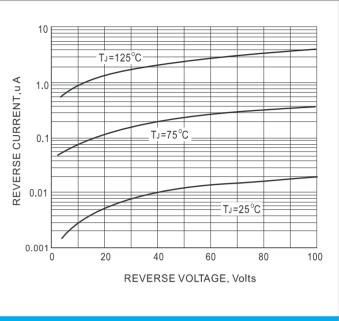
PARAMETER	SYMBOL	BAS16-AU	BAS19-AU	BAS20-AU	BAS21-AU	UNIT
Marking Code		A6	A8	A80	A82	
Reverse Voltage	V_R	75	100	150	200	V
Peak Reverse Voltage	V_{RM}	100	120	200	250	V
Rectified Current (Average), Half Wave Rectification With Resistive Load And f >50Hz	I _o	250	200	200	200	mA
Peak Forward Surge Current, tp=1µs Single Half Sine-Wave Superimposed On Rated Load	I _{FSM}	2	2.5	2.5	2.5	A
Power Dissipation Derate Above 25 °C	P _{TOT}	350	350	350	350	mW
Maximum Forward Voltage	V _F	0.855@10mA	1.0@100mA	1.0@100mA	1.0@100mA	V
Maximum Dc Reverse Current At Rated Dc Blocking Voltage T _J =25 °C	I _R	1	1	1	1	μА
Typical Junction Capacitance (Notes1)	CJ	2	1.5	1.5	1.5	pF
Maximum Reverse Recovery Time (Note 2)	T_RR	6	50	50	50	nS
Typical Thermal Resistance (Note 3)	$R_{\theta JA}$	357			°C/W	
Operating Junction Temperature And Storage Temperature Range	T_J, T_STG	-55 to +150				°C

NOTES:

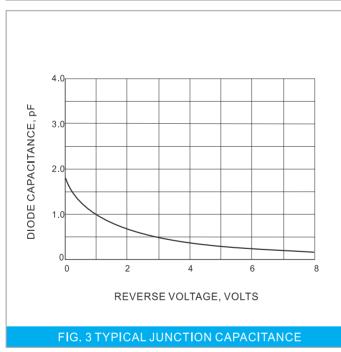
- 1. C_J at $V_R=0$, f=1MHz.
- 2. From $I_F{=}10mA$ to I_R =1mA, $V_R{=}6Volts,\,R_L{=}100\Omega.$
- 3. Mounted on a FR-4 PCB, single-sided copper, with 100cm² copper pad area.

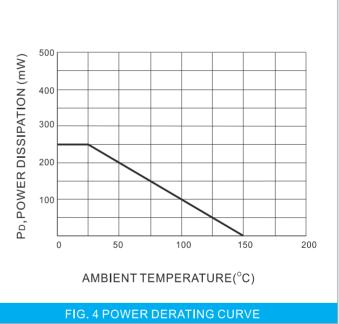












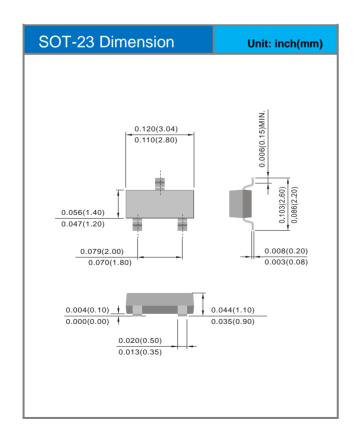
3 TYPICAL JUNCTION CAPACITANCE FIG. 4 POWER DERATING CURV

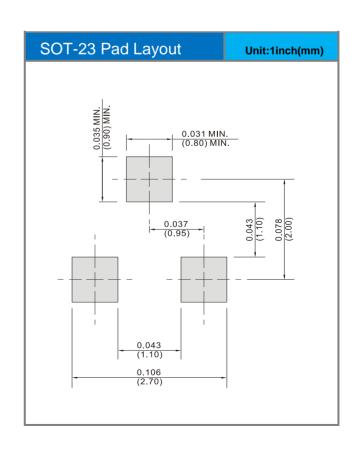


Product and Packing Information

Part No.	Package Type	Packing Type	Marking
BAS16-AU	SOT-23	3K pcs / 7" reel	A6
BAS19-AU	SOT-23	3K pcs / 7" reel	A8
BAS20-AU	SOT-23	3K pcs / 7" reel	A80
BAS21-AU	SOT-23	3K pcs / 7" reel	A82

Packaging Information & Mounting Pad Layout







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